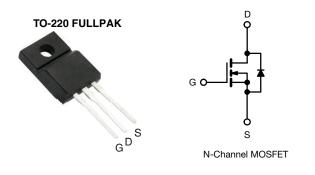
Vishay Siliconix



Power MOSFET



PRODUCT SUMMA	RY	
V _{DS} (V)	200)
R _{DS(on)} (Ω)	$V_{GS} = 10 V$	0.40
Q _g max. (nC)	43	
Q _{gs} (nC)	7.0	
Q _{gd} (nC)	23	
Configuration	Sing	le

FEATURES

- Isolated package
- High voltage isolation = 2.5 kV_{RMS} (t = 60 s; f = 60 Hz)
- Sink to lead creepage distance = 4.8 mm
- Dynamic dV/dt rating
- Low thermal resistance
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220 FULLPAK eliminates the need for additional insulating hardware in commercial-industrial applications. The molding compound used provides a high isolation capability and a low thermal resistance between the tab and external heatsink. The isolation is equivalent to using a 100 micron mica barrier with standard TO-220 product. The FULLPAK is mounted to a heatsink using a single clip or by a single screw fixing.

ORDERING INFORMATION	
Package	TO-220 FULLPAK
Lead (Pb)-free	IRFI630GPbF

PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V _{DS}	200		
Gate-source voltage			V _{GS}	± 20	- V	
Continuous drain current	V =+ 10 V	T _C = 25 °C		5.9		
Continuous drain current	V _{GS} at 10 V	T _C = 100 °C	ID	3.7	А	
Pulsed drain current ^a			I _{DM}	24		
Linear derating factor				0.28	W/°C	
Single pulse avalanche energy ^b			E _{AS}	230	mJ	
Repetitive avalanche current ^a			I _{AR}	5.9	А	
Repetitive avalanche energy ^a			E _{AR}	3.5	mJ	
Maximum power dissipation $T_{C} = 25 \text{ °C}$			PD	35	W	
Peak diode recovery dV/dt ^c			dV/dt	5.0	V/ns	
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	*0	
Soldering recommendations (peak temperature) ^d	For	For 10 s		300	- °C	
Mounting torque	6-32 or M3 screw			10	lbf ∙ in	
Mounting torque	0-32 OF I	vio screw		1.1	N ⋅ m	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. V_{DD} = 50 V, starting T_J = 25 °C, L = 9.9 mH, R_g = 25 Ω , I_{AS} = 5.9 A (see fig. 12)

c. $I_{SD} \leq 5.9$ A, dI/dt ≤ 120 A/µs, $V_{DD} \leq V_{DS},$ $T_J \leq 150~^\circ\text{C}$

d. 1.6 mm from case

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COMPLIANT

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THERMAL RESISTANCE RAT	NGS							
PARAMETER	SYMBOL	TYP	-	MAX.	MAX.		UNIT	
Maximum junction-to-ambient	R _{thJA}	- 65			20.44			
Maximum junction-to-case (drain)	R _{thJC}	- 3.6					°C/W	
	4							
SPECIFICATIONS (T _J = 25 °C, u	unless otherw	ise noted)						
PARAMETER	SYMBOL	TES	T CONDITI	IONS	MIN.	TYP.	MAX.	UNIT
Static								
Drain-ssource breakdown voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 2	50 µA	200	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C,	I _D = 1 mA	-	0.24	-	V/°C
Gate-source threshold voltage	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 2	250 μA	2.0	-	4.0	V
Gate-source leakage	I _{GSS}	,	$V_{GS} = \pm 20$	V	-	-	± 100	nA
7		V _{DS} =	= 200 V, V _{GS}	_s = 0 V	-	-	25	
Zero gate voltage drain current	IDSS	V _{DS} = 160 V	/, V _{GS} = 0 V	, T _J = 125 °C	-	-	250	μA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	I _D :	= 3.5 A ^b	-	-	0.40	Ω
Forward transconductance	9 _{fs}	V _{DS} =	= 50 V, I _D = 3	3.5 A ^b	3.2	-	-	S
Dynamic					•	•	•	
Input capacitance	C _{iss}	$V_{GS} = 0 V,$ $V_{DS} = 25 V,$ f = 1.0 MHz, see fig. 5		-	800	-	pF	
Output capacitance	C _{oss}			-	240	-		
Reverse transfer capacitance	C _{rss}			-	76	-		
Drain to sink capacitance	С		f = 1.0 MHz	7	-	12	-	1
Total gate charge	Qg				-	-	43	
Gate-source charge	Q _{gs}		, V _{DS} = 160 V, . 6 and 13 ^b	-	-	7.0	nC	
Gate-drain charge	Q _{gd}		366 115	J. 0 and 10	-	-	23	
Turn-on delay time	t _{d(on)}	V_{DD} = 100 V, I _D = 5.9 A, R _g = 12 Ω, R _D = 16 Ω, see fig. 10 ^b		-	9.4	-	- ns	
Rise time	t _r			-	28	-		
Turn-off delay time	t _{d(off)}			-	39	-		
Fall time	t _f		see lig. 10 -		-	20	-	1
Gate input resistance	Rg	f = 1	MHz, open	drain	0.6	-	3.3	Ω
Internal drain inductance	L _D	Between l 6 mm (0.25	") from		-	4.5	-	الم
Internal source inductance	L _S	die contact		-	7.5	-	nH	
Drain-Source Body Diode Characteristi	cs							
Continuous source-drain diode current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	5.9	A	
Pulsed diode forward current ^a	I _{SM}			-	-	24		
Body diode voltage	V _{SD}	T _J = 25 °C	, I _S = 5.9 A,	$V_{GS} = 0 V^{b}$	-	-	2.0	V
Body diode reverse recovery time	t _{rr}	T ₁ = 25 °C I-	= 5 9 A dl/	dt = 100 A/µs ^b	-	170	340	ns
Body diode reverse recovery charge	Q _{rr}	1J = 20 0, IF	– 0.0 A, ulv	at = 100 Avµ3	-	1.1	2.2	μC
Forward turn-on time	t _{on}	Intrinsic tu	ırn-on time i	is negligible (turn	-on is dor	minated b	y L _S and	L _D)

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. Pulse width $\leq 300~\mu s;~duty~cycle \leq 2~\%$

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

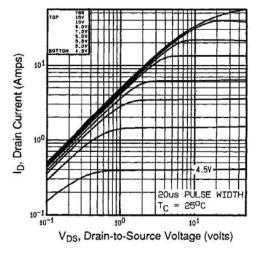


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

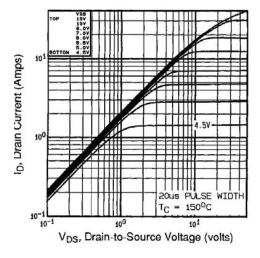


Fig. 2 - Typical Output Characteristics, T_C = 150 °C

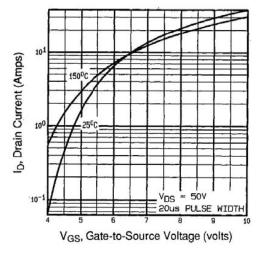


Fig. 3 - Typical Transfer Characteristics

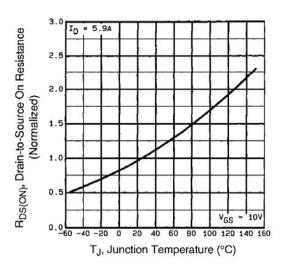


Fig. 4 - Normalized On-Resistance vs. Temperature

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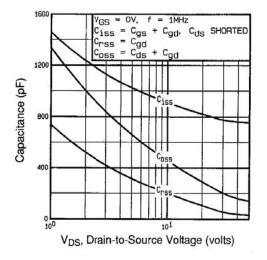


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

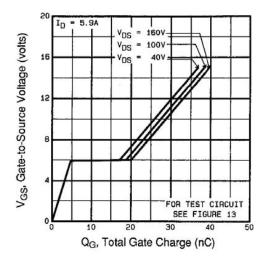


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

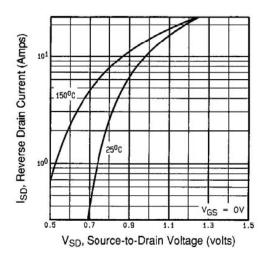


Fig. 7 - Typical Source-Drain Diode Forward Voltage

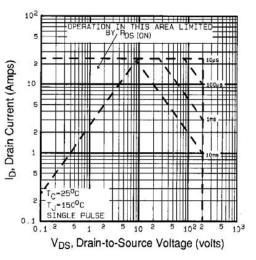


Fig. 8 - Maximum Safe Operating Area

4



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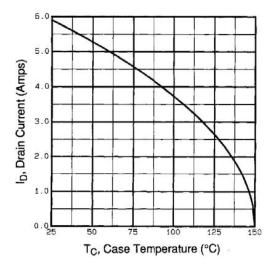


Fig. 9 - Maximum Drain Current vs. Case Temperature

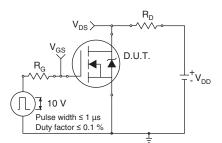


Fig. 10a - Switching Time Test Circuit

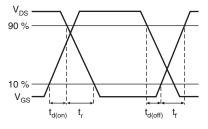
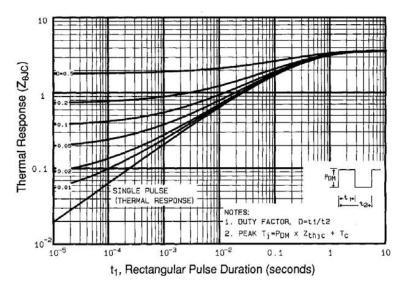


Fig. 10b - Switching Time Waveforms





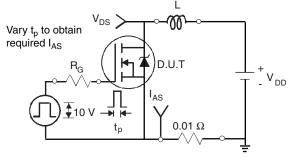
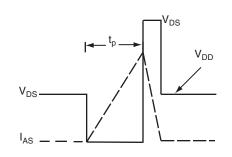
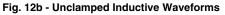


Fig. 12a - Unclamped Inductive Test Circuit





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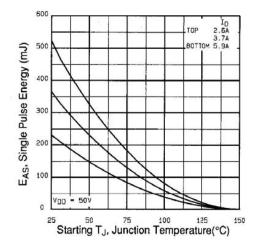
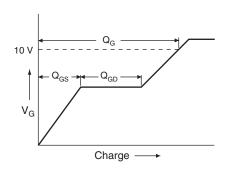


Fig. 12c - Maximum Avalanche Energy vs. Drain Current



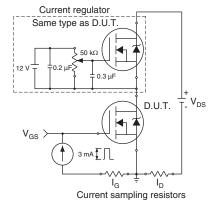


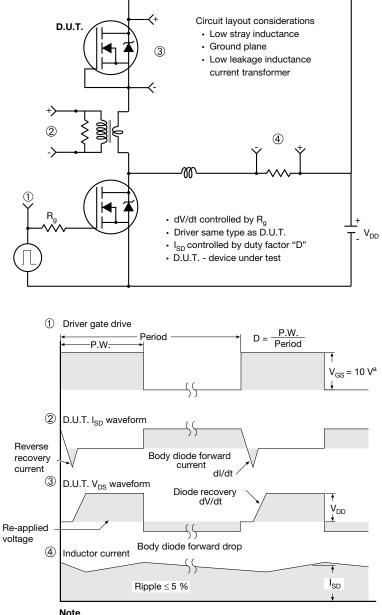
Fig. 13a - Basic Gate Charge Waveform



6



Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5$ V for logic level devices

Fig. 14 - For N-Channel

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TO-220 FULLPAK (High Voltage)

OPTION 1: FACILITY CODE = 9



		MILLIMETERS	
DIM.	MIN.	NOM.	MAX.
A	4.60	4.70	4.80
b	0.70	0.80	0.91
b1	1.20	1.30	1.47
b2	1.10	1.20	1.30
С	0.45	0.50	0.63
D	15.80	15.87	15.97
е		2.54 BSC	
E	10.00	10.10	10.30
F	2.44	2.54	2.64
G	6.50	6.70	6.90
L	12.90	13.10	13.30
L1	3.13	3.23	3.33
Q	2.65	2.75	2.85
Q1	3.20	3.30	3.40
ØR	3.08	3.18	3.28

Notes

- 1. To be used only for process drawing
- 2. These dimensions apply to all TO-220 FULLPAK leadframe versions 3 leads
- 3. All critical dimensions should C meet $C_{pk} > 1.33$
- 4. All dimensions include burrs and plating thickness
- 5. No chipping or package damage
 6. Facility code will be the 1st character located at the 2nd row of the unit marking

1



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OPTION 2: FACILITY CODE = Y



	MILLIN	IETERS	INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
А	4.570	4.830	0.180	0.190	
A1	2.570	2.830	0.101	0.111	
A2	2.510	2.850	0.099	0.112	
b	0.622	0.890	0.024	0.035	
b2	1.229	1.400	0.048	0.055	
b3	1.229	1.400	0.048	0.055	
С	0.440	0.629	0.017	0.025	
D	8.650	9.800	0.341	0.386	
d1	15.88	16.120	0.622	0.635	
d3	12.300	12.920	0.484	0.509	
E	10.360	10.630	0.408	0.419	
е	2.54	BSC	0.100) BSC	
L	13.200	13.730	0.520	0.541	
L1	3.100	3.500	0.122	0.138	
n	6.050	6.150	0.238	0.242	
ØP	3.050	3.450	0.120	0.136	
u	2.400	2.500	0.094	0.098	
V	0.400	0.500	0.016	0.020	

DWG: 5972

Notes

1. To be used only for process drawing

2. These dimensions apply to all TO-220 FULLPAK leadframe versions 3 leads

3. All critical dimensions should C meet $C_{pk} > 1.33$

4. All dimensions include burrs and plating thickness

5. No chipping or package damage
6. Facility code will be the 1st character located at the 2nd row of the unit marking

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